

| Doc Name                       | DL2106A-ESP8266 User's Manual |             |            |       |  |
|--------------------------------|-------------------------------|-------------|------------|-------|--|
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# DL2106A-ESP8266 User's Manual



Hangzhou Delan Technology Co., Ltd



# **Version History**

| Version | Revised Date  | Revised by   | Participant | Revision Contents | Remarks |
|---------|---------------|--------------|-------------|-------------------|---------|
| 1.0.0   | Mar. 28, 2016 | Murphy Shawn |             | First Released    |         |
|         |               |              |             |                   |         |
|         |               |              |             |                   |         |
|         |               |              |             |                   |         |





# **Contents**

| DL2106A-ESP8266 User's Manual           | 1    |
|---|------|
| Version History                         | 2    |
| Contents                                | 3    |
| 1. Introduction                         | 4    |
| 1.1 Summary                             | 4    |
| 1.1.1 Features                          | 4    |
| 1.1.2 Basic Parameters                  | 5    |
| 1.1.3 Main Applications                 | 6    |
| 1.2 Introduction of hardware            | 8    |
| 1.2.1 Pin Definitions                   | 8    |
| 1.2.2 Electrical Characteristics        | . 10 |
| 1.2.3Size                               |      |
| 1.2.4Antenna                            | . 13 |
| 1.2.5 Peripheral circuits               | . 14 |
| 1.2.6 Precautions in designing your PCB | . 15 |
| 1.2.7 Furnace temperature curve         | . 16 |



## 1. Introduction

### 1.1 Summary

#### 1.1.1 Features

Support 802.11 b/g/n Wireless Standards.

WIFI @2.4GHz, support WPA / WPA2 safe mode.

Support different working mode: STA / AP / STA+AP.

Micro Sizes: 15mm \* 30mm \* 3.5mm.

10 bit high precision ADC inside.

TCP/IP protocol stack inside.

TR switch, BALUN, LNA, PA (Power Amplifier) and network configuration inside.

PLL, Stabilizer and power management tools inside.

Holding current is  $10\mu A$ , turn-off current is less than  $5\mu A$ .

Low power 32 bit MCU inside, which can also be an application processor.

Support SDIO 2.0, SPI, UART and other interfaces.

Working temperature: from -40° $\mathbb{C}$  to 125° $\mathbb{C}$ .



# 1.1.2 Basic Parameters

| Types    | Parameters           | Value                                    |  |
|----------|----------------------|--|--|
|          | Certification        | CCC / FCC / CE                           |  |
|          | Standard             | 802.11b/g/n                              |  |
|          | Frequency            | 2412MHZ-2462MHZ                          |  |
|          |                      | 802.11b: 16.95±1dBm                      |  |
|          | Transmit Power       | 802.11g: 14.96±1dBm                      |  |
| Wireless |                      | 802.11n: 14.86±1dBm                      |  |
|          |                      | 802.11b: (11Mbps) -91dBm                 |  |
|          | Receiver Sensitivity | 802.11g: (54Mbps) -75dBm                 |  |
|          |                      | 802.11n: (MCS7) -72dBm                   |  |
|          | Antenna              | Internal: default                        |  |
| Hardware | Data Interface       | GPIO/PMW, UART/SDIO/SPI/I <sup>2</sup> C |  |
|          | Operating Voltage    | 3.0~3.6V                                 |  |



|          | Working Temperature   | -40~125℃  |  |
|----------|-----------------------|---|--|
|          | Storage Temperature   | Room temperature  |  |
|          | Size                  | 15mm * 30mm * 3.5mm   |  |
|          | Wireless Network Type | AP/STA/AP+STA   |  |
|          | Security Mechanism    | WPA-PSK / WPA2-PSK  |  |
| Software | Encryption type       | WEP/TKIP/AES  |  |
|          | Firmware Upgrading    | Remote (cloud) or local (Serial interface).                   |  |
|          | Custom Development    | Support customizing your server and redeveloping based on SDK |  |
|          | Network Protocols     | IPv4, TCP / UDP / HTTP / FTP                                  |  |
|          | Users' Configure      | AT+ instruction set, website operation,                       |  |
|          |                       | IOS, Android terminal.  |  |

# 1.1.3 Main Applications

Smart Plug



Intelligent Home

Internet of Things

Wireless control in industry

**Baby Monitor** 

Network video recorder

Wireless Sensor & Industrial Control

**Smart Wearables** 

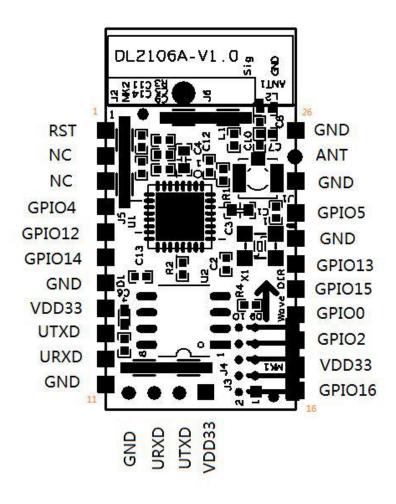
**Light Control** 





## 1.2 Introduction of hardware

## 1.2.1 Pin Definitions



| Pin | Network Label | Characteristic | Description                        |
|-----|---------------|----------------|------------------------------------|
| 1   | RST           | O, TTL 3.3V    | Reset outside, Low Level Effective |



| 2  | NC        | NC          | NC                               |
|----|-----------|-------------|----------------------------------|
| 3  | NC        | NC          | NC                               |
| 4  | UART0_CTS | O, TTL 3.3V | GPIO/ UART0_CTS                  |
| 5  | UART0_RTS | O, TTL 3.3V | GPIO/ UART0_RTS                  |
| 6  | SPI_CLK   | O, TTL 3.3V | SPI Clock                        |
| 7  | GNF       | GND         | Ground                           |
| 8  | VDD 3.3   | 3.3V        | Power                            |
| 9  | UART0_TXD | O, TTL 3.3V | UART0_TXD, data serial interface |
| 10 | UARTO_RXD | I, TTL 3.3V | UART0_RXD, data serial interface |
| 11 | GNF       | GND         | Ground                           |
| 12 | GNF       | GND         | Ground                           |
| 13 | UART0_RXD | O, TTL 3.3V | The same as PIN 10.              |
| 14 | UART0_TXD | I, TTL 3.3V | The same as PIN 9.               |
| 15 | VDD 3.3   | 3.3V        | Power                            |
| 16 | FLASH_CS  | I, TTL 3.3V | Flash signal.                    |



| 17 | VDD 3.3                  | 3.3V                       | Power  |
|----|--------------------------|----------------------------|--|
| 18 | НМ0                      | TTL 3.3V                   | Mode configuration pin, forbidden for users  |
| 19 | GPIO3                    | TTL 3.3V                   | Spare GPIO   |
| 20 | I <sup>2</sup> S0_WSIGND | TTL 3.3V                   | GPIO/ SPIM_CSI/ LED  |
| 21 | I <sup>2</sup> C_CLK     | TTL 3.3V                   | I <sup>2</sup> C Clock I <sup>2</sup> C_CLK. Spare. Used as I <sup>2</sup> C pull-up-4.7K outside. |
| 22 | GND                      | GND                        | Ground   |
| 23 | AP_MODE                  | Pull-up-10K,<br>I, TTL3.3V | Short-circuit to choose AP or STA. High level as default, pull down for 5s to enter AP mode.       |
| 24 | GND                      | GND                        | Ground   |
| 25 | RF_ANT                   | О                          | Output of RF, accessible for external antenna  |
| 26 | GND                      | GND                        | Ground   |

Directions: I – Input, O – Output, GND – Ground.

## 1.2.2 Electrical Characteristics

**Electrical Characteristics** 



| Parameters                    | Conditions               | Minimum | Typical             | Maximum      |
|-------------------------------|--------------------------|---------|---------------------|--------------|
| Storage<br>Temperature        |                          | -45℃    | Room<br>temperature | <b>125</b> ℃ |
| Maximum Soldering Temperature | IPC/ JEDEC/<br>J-STD-020 |         |                     | 260℃         |
| Working Voltage               |                          | 0V      | 3.3V                | 3.6V         |
| I/O Voltage                   |                          | 0V      |                     | 3.3V         |
| I/O Current                   | 7_                       |         |                     | 12mA         |
| Electrostatic<br>Release      | TAMB=25°C                |         | 2KV                 |              |

# Power

| Parameters                           | Conditions | Minimum | Typical | Maximum |
|--------------------------------------|------------|---------|---------|---------|
| Working Voltage                      |            | 3.0V    | 3.3V    | 3.6V    |
| 802.11.b, CCK 11Mbps, P<br>OUT=17dBm |            |         | 170mA   |         |
| 802.11.g, OFDM 54Mbps,               |            |         | 140mA   |         |



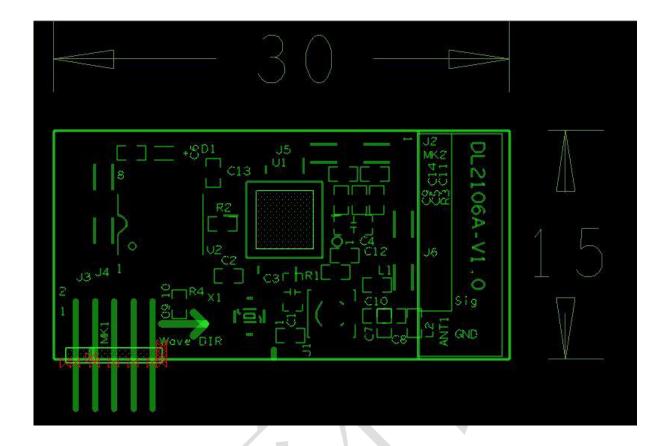
| OUT=15dBm                   |   |         |  |
|-----------------------------|---|---------|--|
| 802.11.n, MCS7, P           |   | 120mA   |  |
| OUT=13dBm                   |   | 120111A |  |
| 802.11.b, 1K, -80dBm        |   | 50mA    |  |
| 802.11.g, 1K, -70dbm        |   | 56mA    |  |
| 802.11.n, 1K, -65dbm        |   | 56mA    |  |
| Modem-sleep                 | X | 15mA    |  |
| Light-sleep                 |   | 0.9mA   |  |
| Deep-sleep                  |   | 10μΑ    |  |
| Power off                   |   | 5μΑ     |  |
| Working current (Low power) |   | 10mA    |  |

# 1.2.3Size

Physical size: 15mm \* 30mm \* 3.5mm. Thickness of PCB: 1.0mm.

Graph of PCB:





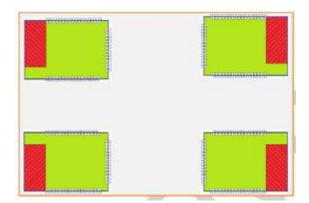
#### 1.2.4Antenna

#### 1.2.4.1 Internal

Internal antenna is default. If you choose internal antenna, you'd to pay attention to the followings:

- 1) The place where antenna sets should be clear.
- 2) Antenna should be far from metal, 10mm at least away from high devices.
- 3) No metal shell where antenna set.
- 4) To reduce possible influence on wireless signal from your PCB, Suggested locations of DL2106A in your PCB are as follows:





### 1.2.4.2 External

DL2106A offers interface of external antenna (Pin 2, ANT).

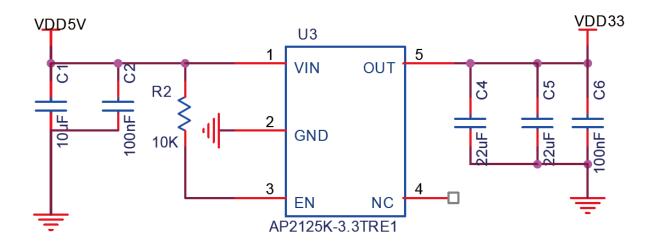
Parameters of external antenna are as follows:

| Frequency       | 2.4~2.5GHZ                                |
|-----------------|---|
| Impedance       | 50 Ohm                                    |
| VSWR            | 2(max)                                    |
| Return Loss     | -10dB (Max)                               |
| Connection Type | Choose according to the actual condition. |

# 1.2.5 Peripheral circuits

Reference Peripheral circuits (Transform 5V into 3.3V)



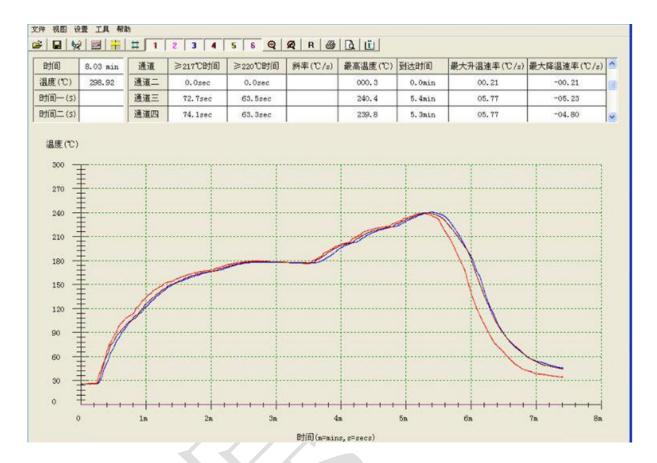


# 1.2.6 Precautions in designing your PCB

- 1) Please use the standard schematic DELAN offered and the general PCB package.
- 2) When you design your PCB near the antenna, please send your design to us to review.



### 1.2.7 Furnace temperature curve



#### **FCC STATEMENT:**

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

**Warning:** Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to



provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

Reorient or relocate the receiving antenna.

Increase the separation between the equipment and receiver.

Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.

Consult the dealer or an experienced radio/TV technician for help.

## **FCC Radiation Exposure Statement:**

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.



#### FCC INFORMATION (additional)

#### **OEM INTEGRATION INSTRUCTIONS:**

This device is intended only for OEM integrators under the following conditions: The module must be installed in the host equipment such that 20 cm is maintained between the antenna and users, and the transmitter module may not be co-located with any other transmitter or antenna. The module shall be only used with the internal antenna(s) that has been originally tested and certified with this module. As long as 3 conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

#### Validity of using the module certification:

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization for this module in combination with the host equipment is no longer considered valid and the FCC ID of the module cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

#### End product labeling:

This transmitter module is authorized only for use in device where the antenna may be installed such that 20 cm may be maintained between the antenna and users. The final end product must be labeled in a visible area with the following: "Contains FCC ID: 2AILF-DL2106A".

#### Information that must be placed in the end user manual:

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual. This device must be kept away from all persons by 20cm or more and installations using less distance, or installations using antennas with gain greater than that with which this was Certified will require additional approvals.

Antenna Specification:

Type: PCB Antenna Model: DL2106A

Brand: N.A. Gain: 3dBi